## **SEIKO EPSON CORPORATION**

# MHz Range Crystal unit FA-238V

Product name FA-238V 12.000000 MHz 20.0 +30.0-30.0 Product Number / Ordering code Q22FA23V00149xx

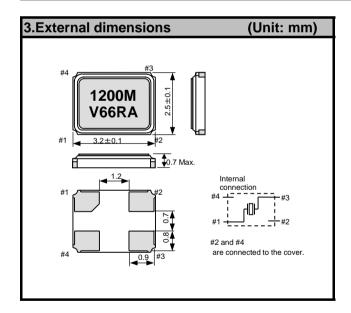
Please refer to the 5.Packing information about xx (last 2 digits)

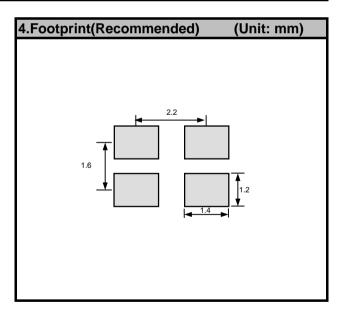
Pb free / Complies with EU RoHS directive

Reference weight Typ. 16 mg

1.Absolute maximum ratii	ngs					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions / Remarks
Storage temperature	T_stg	-40	-	+125	ç	Storage as single product
Operating temperature	T_use	-40	-	+105	°C	

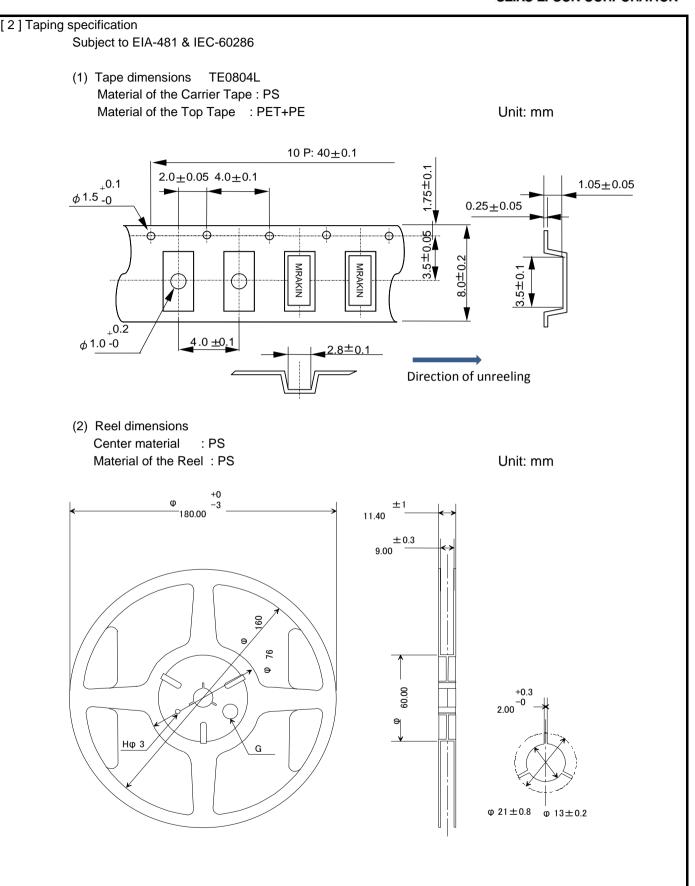
2.Specifications(characteristics)							
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions / Remarks	
Nominal frequency	f_nom	=	12.000000	_	MHz	Fundamental	
Frequency tolerance	f_tol	-30	-	+30	x 10- <sup>6</sup>	@+25°C	
Frequency Stability over temperature	f_tem	-30	-	+30	x 10 <sup>-6</sup>	-20°C to +70°C	
Operating temperature	T_use	-20	-	+70	°C		
Level of drive	DL	10	100	200	μW		
Load capacitance	CL	_	20	_	pF		
Motional resistance (ESR)	R1	-	-	100	Ω		
Motional capacitance	C1	-	2.01	-	fF		
Motional inductance	L1	-	87.68	-	mH		
Shunt capacitance	C0	-	0.96	-	pF		
Frequency aging	f_age	-5	_	+5	x10 <sup>-6</sup> /yea	@+25°C, First year	





5.Packing	informati	ion		
[ 1 ]Product number last 2 digits code (xx) description		The recommended code is "17"		
	Q22FA23	V00149xx		
	Code	Condition	Code	Condition
	01	Any Q'ty vinyl bag(Tape cut)	14	1000pcs / Reel
	11	Any Q'ty / Reel	15	2000pcs / Reel
	12	250pcs / Reel	00	3000pcs / Reel
	13	500pcs / Reel	17	4000pcs / Reel

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## 6.Reflow profile

Reflow condition

Pre Heating Temperature

 $Tp1 \sim Tp2 = +170 \circ C$ 

**Heating Temperature** 

TMIt = +220 ° C

Peek Temperature

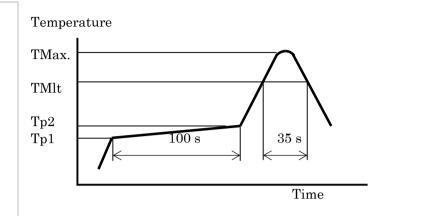
TMax. =  $+260^{\circ}$  C

Point of measuring

In case of Solderability

Terminal.

In case of Resistance to soldering heat Surface.



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